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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Seung Hwan CHO	06/20/2007
Bo Sung KIM	06/20/2007
Keun Kyu SONG	06/20/2007

### **RECEIVING PARTY DATA**

Name:	Samsung Electronics Co., Ltd	
Street Address:	416, Maetan-dong, Yeongtong-gu,	
Internal Address:	Suwon-si	
City:	Gyeonggi-do	
State/Country:	KOREA, REPUBLIC OF	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11766597

### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	Hugh H. Matsubayashi

Total Attachments: 2

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PATENT REEL: 019467 FRAME: 0020

#### ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

Seung Hwan CHO	of	105-1001, Sung-won Sangtevill Apt., 674-1 Sun-na	
		Maeul, Jung-ri, Dongtan-myeon, Hwaseong-si,	
		Gyeonggi-do, Korea	
Bo Sung KIM	of	3F, 474-20 Bangbae 2-dong, Seocho-gu, Seoul, Korea	
Keun Kyu SONG	of	301-1603, Woomi 1-cha, 31BL, Jukjun Tackji-jigu Jukjun-dong, Yongin-si, Gyeonggi-do, Korea	

hereby sell, assign and transfer to SAMSUNG ELECTRONICS CO., LTD., a corporation, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea, its successors and assigns, the entire right, title and interest throughout the world in our invention in

ORGANIC THIN FILM TRANSISTOR SUBSTRATE AND FABRICATION METHOD THEREFOR

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

PATENT REEL: 019467 FRAME: 0021

Executed this 20 day of	, 2007.
	Cho Deurf Hwan Seung Hwan CHO
<del></del>	Seung Hwan CHO
WITNESSED:	
Signature	<del></del>
Date	<del></del>
Type or print name of witness	
Executed this 20 day of June	, 2007.
	Bo Sung KIM
	Do Swiig IIII
WITNESSED:	
Signature	
Date	<del></del>
Type or print name of witness	
Executed this with day of gunt	, 2007.
	Song Kem Kyu Keun Kyu SONG
WITNESSED:	Keun Kyu SONG
Signature	<del></del>
Date	<del></del>
Type or print name of witness	<del></del>

**PATENT** 

**REEL: 019467 FRAME: 0022**